STTH806DTI



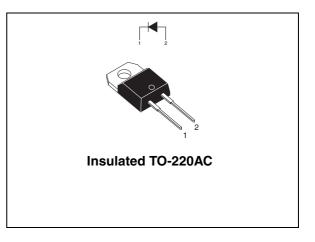
Tandem 600 V hyperfast boost diode

Table 1. Main product characteristics

Features and benefits

- Especially suited as boost diode in continuous mode power factor correctors and hard switching conditions
- Designed for high di/dt operation. Hyperfast recovery current to compete with SiC devices. Allows downsizing of mosfet and heatsinks
- Internal ceramic insulated devices with equal thermal conditions for both 300 V diodes
- Insulation (2500 V_{RMS}) allows placement on same heatsink as mosfet and flexible heatsinking on common or separate heatsink
- Static and dynamic equilibrium of internal diodes are warranted by design
- Package Capacitance: C = 7 pF

 Table 3.
 Absolute ratings (limiting values)



Description

The TURBOSWITCH "H" is an ultra high performance diode composed of two 300 V dice in series. TURBOSWITCH "H" family drastically cuts losses in the associated MOSFET when run at high dI_F/dt .

Table 2.Order codes

Part number	Marking
STTH806DTI	STTH806DTI

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	RMS forward voltage	14	А	
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	180	А
T _{stg}	Storage temperature range	-65 to + 150	°C	
Тj	Maximum operating junction temperature		150	° C

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1 Characteristics

Table 4. Thermal parameter

Symb	Parameter	Value	Unit
R _{th(j-}	Junction to case thermal resistance	2.6	°C/W

Table 5. Static electrical characteristics

Symbol	Parameter	Test co	Min.	Тур	Max.	Unit		
I _B ⁽¹⁾	Reverse leakage current	$T_j = 25^\circ C$	VV			10	μA	
'R `	$T_j = 125^{\circ} C$	$T_j = 125^\circ C$ $V_R = V_{RRM}$	$T_j = 125^\circ C$ $R = V_{RRM}$	$T_j = 125^{\circ} C$		15	100	μΑ
V _F ⁽²⁾	Forward voltage drop	$T_j = 25^\circ C$	– I _F = 8 A			3.6	V	
VF V		T _j = 150° C	IF = 0 A		1.95	2.4	v	

1. Pulse test: tp = 100 ms, δ < 2%

2. Pulse test: tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: P = 1.7 x $I_{F(AV)}$ + 0.087 ${I_F}^2_{(RMS)}$

Table 6. Dynamic characteristics

Symbol	Parameter		Test conditions			Max	Unit
			$I_{F} = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_{R} = 1 \text{ A}$		13		
t _{rr}	Reverse recovery time	T _j = 25° C	I _F = 1 A, dI _F /dt = - 50 A/μs V _R = 30 V			30	ns
I _{RM}	Reverse recovery current	T _j = 125° C			4	5.5	
S	Reverse recovery softness factor		T _j = 125° C	I _F = 8 A, V _R = 400, Vdl⊨/dt = - 200 A/us		0.4	
Q _{rr}	Reverse recovery charges				50		

Table 7. Turn-on switching characteristics

Symbol	Parameter	Test conditions			Тур	Max.	Unit
t _{fr}	Forward recovery time	$T_j = 25^\circ C$	I _F = 8 A, dI _F /dt = 100 A/μs V _{FR} = 1.1 x V _F max			200	ns
V _{FP}	Forward recovery voltage	$T_j = 25^\circ C$	I _F = 8 A, dI _F /dt = 100 A/μs			7	V



Figure 1. Conduction losses versus average Figure 2. current



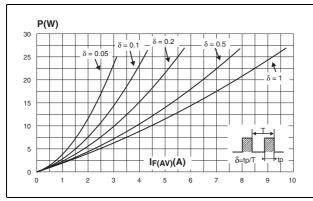


Figure 3. **Relative variation of thermal** impedance junction to case versus pulse duration

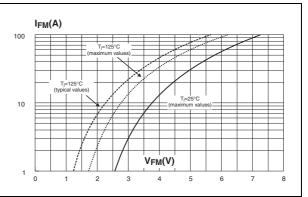
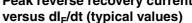


Figure 4. Peak reverse recovery current



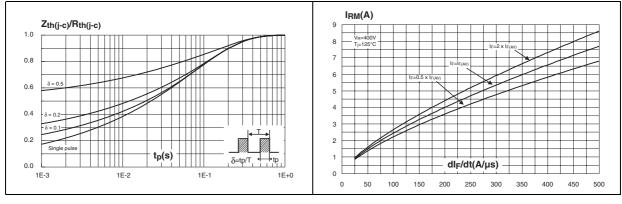
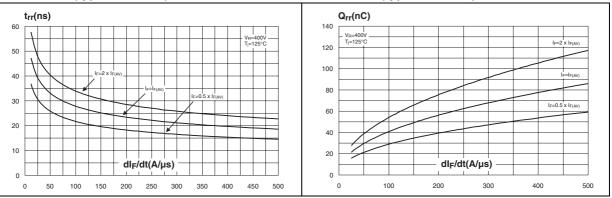


Figure 5. Reverse recovery time versus dl_F/dt Figure 6. (typical values)

Reverse charges versus dl_F/dt (typical values)

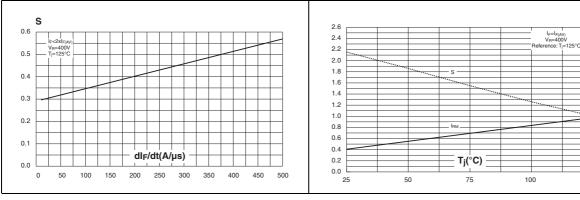




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Figure 7. Softness factor versus dl_F/dt (typical values)

Figure 8. Relative variation of dynamic parameters versus junction temperature (reference: $T_j = 125^{\circ} C$)



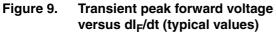
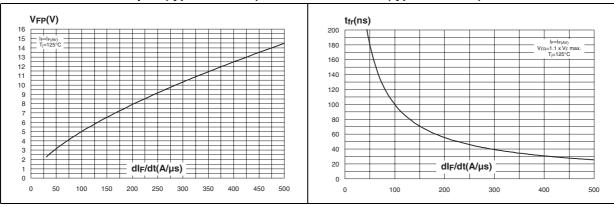


Figure 10. Forward recovery time versus dl_F/dt (typical values)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: C
- Recommended torque value: 0.4 to 0.6 Nm

Table 8. TO-220AC insulated dimensions

					Dimer	nsions		
		Ref.	Mi	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
В	с	a1		3.75			0.147	
← →	b2,	a2	13.00		14.00	0.511		0.551
		В	10.00		10.40	0.393		0.409
		b1	0.61		0.88	0.024		0.034
14 A		b2	1.23		1.32	0.048		0.051
		С	4.40		4.60	0.173		0.181
	c2 ↔	c1	0.49		0.70	0.019		0.027
12 a2		c2	2.40		2.72	0.094		0.107
		е	4.80		5.40	0.189		0.212
↓ + ↓ + ↓ + ↓ + ↓ + ↓ + ↓ + ↓ + ↓ + ↓ +	M ↔ c1	F	6.20		6.60	0.244		0.259
e		ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		Μ		2.60			0.102	

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3 Ordering information

Table 9.Ordering information

Part number	Marking	Package	Weight	Base qty	Delivery mode
STTH806DTI	STTH806DTI	TO-220AC	2.3 g	50	Tube

4 Revision history

Table 10. Revision history

Date	Revision	Changes
Oct-2003	2A	Initial release
May-2004 3 Reformatted		Reformatted
29-Jun-2005	4	Corrections to typographical errors. No technical changes.
11-Jul-2007 5		Reformatted to current standards. Removed I _{PEAK} parameter from <i>Table 3: Absolute ratings (limiting values)</i> .

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